

1200V, 25A, Trench FS II Fast IGBT

General Description:

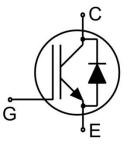
Using NCE's proprietary trench design and advanced FS (Field Stop) second generation technology, the 1200V Trench FSII IGBT offers superior conduction and switching performances, and easy parallel operation;

Features

- Trench FSII Technology offering
- Very low V_{CE(sat)}
- Positive temperature coefficient in V_{CE(sat)}
- Very tight parameter distribution
- High ruggedness, temperature stable behavior

Application

Welding



Schematic diagram

Package Marking and Ordering Information

Device	Device Package	Device Marking
NCE25TD120WT	TO-247	NCE25TD120WT



TO-247

V3.0

Absolute Maximum Ratings (T_C=25°C unless otherwise noted)

Symbol	Parameter	Value	Units
V _{CES}	Collector-Emitter Voltage	1200	V
V _{GES}	Gate- Emitter Voltage	±30	V
1.	Collector Current	50	А
Ic	Collector Current @T _C = 100 °C	25	А
I _{Cpuls}	Pulsed Collector Current, t _p limited by T _{jmax}	75	А
-	turn off safe operating area,V _{CE} =1200V,Tj=150°C	75	Α
I _F	Diode Continuous Forward Current @T _C = 100 °C	12.5	Α
I _{FM}	Diode Maximum Forward Current	37.5	Α
D	Power Dissipation @ T _C = 25°C	365	W
P _D	Power Dissipation @T _C = 100 °C	183	W
T_J, T_{stg}	Operating Junction and Storage Temperature Range	-55 to +175	°C
TL	Maximum Temperature for Soldering	260	°C



Thermal Characteristic

Symbol	Parameter	Value	Units
R _{eJC}	Thermal Resistance, Junction to case for IGBT	0.41	°C/W
R _{eJC}	Thermal Resistance, Junction to case for Diode	0.83	°C/W
R _{θJA}	Thermal Resistance, Junction to Ambient	40	°C/W

Electrical Characteristics (T_C=25°C unless otherwise noted)

0	Dame was to a	Test Conditions		Value			
Symbol	Parameter			Min.	Тур.	Max.	Units
Static Chara	cteristics						
V _{(BR)CES}	Collector-Emitter Breakdown Voltage	V _{GE} =0V,l	_{CE} =1mA	1200			V
I _{CES}	Collector-Emitter Leakage Current	V _{GE} =0V,V	_{CE} =1200V			5	uA
I _{GES(F)}	Gate to Emitter Forward Leakage	V _{GE} =+30\	/,V _{CE} =0V			200	nA
I _{GES(R)}	Gate to Source Reverse Leakage	V _{GE} =-30V	,V _{CE} =0V			200	nA
	0-11	V _{GE} =15V,	Tj=25°C		1.9	2.2	V
$V_{CE(sat)}$	Collector-Emitter Saturation Voltage	I _C =25A,	Tj=150°C		2.2		
$V_{\text{GE(th)}}$	Gate Threshold Voltage	I _C =1mA,	V _{CE} =V _{GE}	4.5		6.5	V
Dynamic Ch	aracteristics						
C _{ies}	Input Capacitance	V _{CE} =30V,V _{GE} =0V, f=1MHz			3094		pF
Coes	Output Capacitance				86		
Cres	Reverse Transfer Capacitance				68		
Qg	Total Gate Charge	V _{CC} =960V, I _C =25A V _{GE} =15V			123		nC
Q _{ge}	Gate to Emitter Charge				28		nC
Q _{gc}	Gate to Collector Charge				60		nC
Switching Cl	haracteristics						
$t_{\text{d(ON)}}$	Turn-on Delay Time				19		
t _r	Rise Time				17		ne
$t_{\text{d(OFF)}}$	Turn-Off Delay Time	V _{CE} =600V,I _C =25A V _{GE} =0/15V, R _g =8Ω			170		ns
t _f	Fall Time				18		
Eon	Turn-On Switching Loss	Inductive	e Load		1.2		
E _{off}	Turn-Off Switching Loss				0.6		mJ
E _{ts}	Total Switching Loss				1.8		

Electrical Characteristics of the Diode (T_C= 25°C unless otherwise specified):

Symbol	Parameter	Test Conditions	Rating			Linita
			Min.	Тур.	Max.	Units
V _{FM}	Diode Forward Voltage	I _F =12.5A		2.1	2.9	V
Trr	Reverse Recovery Time	L -40 FA		118		ns
I _{RRM}	Diode Peak Reverse Recovery Current	I _F =12.5A, di/dt=200A/us		12		Α
Qrr	Reverse Recovery Charge	ui/ui-200A/us		0.72		uC
Pulse width t _{tp} ≤380μs,δ≤2%						

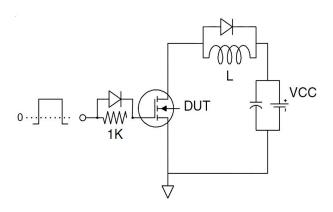


NCE25TD120WT

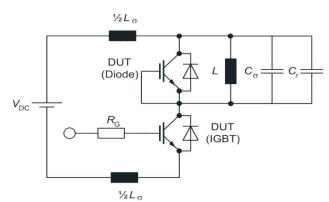
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Test Circuit

1) Gate Charge Test Circuit

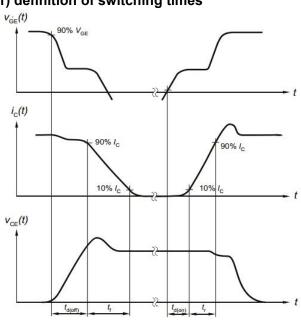


2) Switch Time Test Circuit

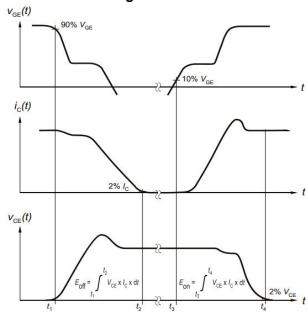


Switching characteristics

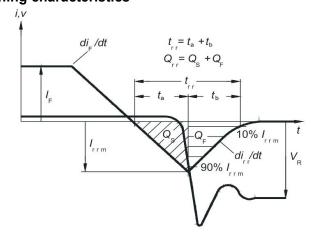
1) definition of switching times



2) definition of switching losses



3) Definition of diode switching characteristics





Typical Electrical and Thermal Characteristics

Figure 1 Output Characteristics

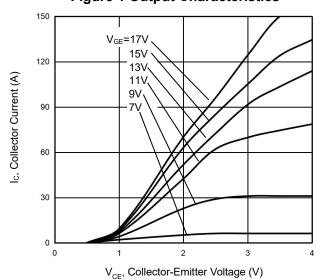


Figure 3 V_{CE(sat)} vs. Case Temperature

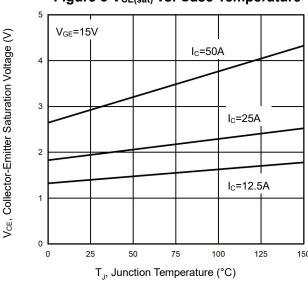


Figure 5 Capacitance Characteristics

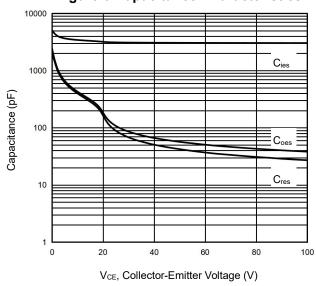


Figure 2 Transfer Characteristics

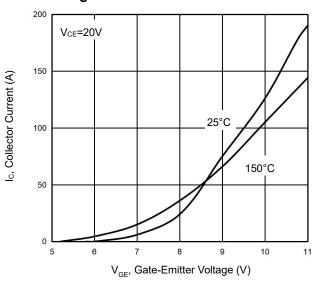


Figure 4 Saturation Voltage vs. V_{GE}

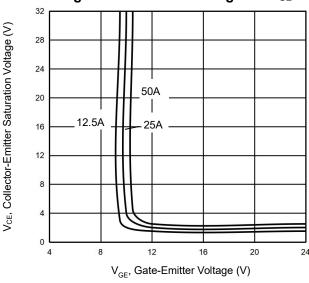
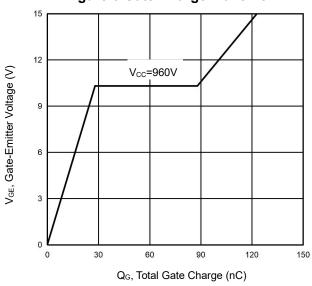
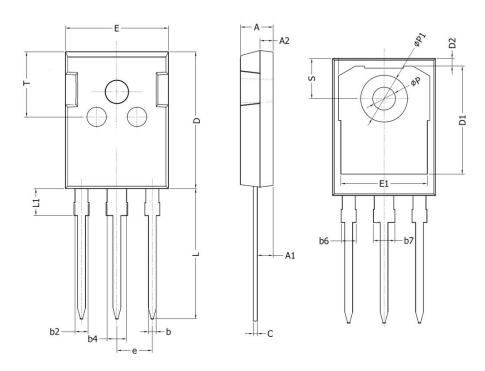


Figure 6 Gate Charge Wave Form





TO-247-3L Package Information



Cumb al	Dimensions	In Millimeters	Dimensions In Inches		
Symbol	Min.	Max.	Min.	Max.	
Α	4.90	5.10	0.193	0.201	
A1	2.31	2.51	0.091	0.099	
A2	1.9	2.1	0.075	0.083	
b	1.16	1.26	0.046	0.050	
b2	1.96	2.06	0.077	0.081	
b4	2.96	3.06	0.117	0.120	
b6	-	2.25	-	0.089	
b7	-	3.25	-	0.128	
С	0.59	0.66	0.023	0.026	
D	20.90	21.10	0.823	0.831	
D1	16.25	16.85	0.640	0.663	
D2	1.05	1.35	0.041	0.053	
E	15.70	15.90	0.618	0.626	
E1	13.10	13.50	0.516	0.531	
е	5.436	BSC	0.214 BSC		
L	19.80	20.10	0.780	0.791	
L1	-	4.30	-	0.169	
Р	3.40	3.60	0.134	0.142	
P1	7.00	7.40	0.276	0.291	
S	6.05	6.25	0.238	0.246	
Т	9.80	10.20	0.386	0.402	

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